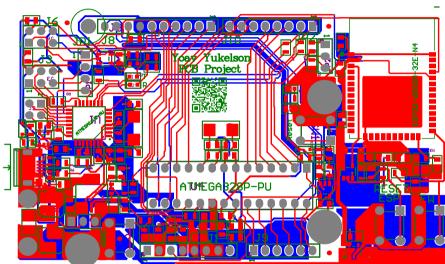


Files *.GTO - Top Overlay *.GTP - Top Paste *.GTS - Top Solder *.GTL - L1 (Positive) *.GBL - L2 (Positive) *.GBS - Bottom Solder *.GBO - Bottom Overlay *.GM2 - Mechanical Drawing *.GM3 - Manufacturing Notes

*.GM4 - Licence *.GM28 - Board Outline



28Pins V1 Contact: yoavyu@gmail.com

Board info Minimum Track: 200um Minimum Gap: 200um Minimum Through Hole VIA: 0.6mm (pad) / 0.3mm (drill). Drilling: L1-L2

- 1. FINISHED PANEL THICKNESS IS NOT CRITICAL: TO BE APPROXIMATELY 1.6mm
- 2. BOARD FINISH: IMMERSION AU/ELECTROLESS Ni; 0.05-0.12 um GOLD; 3-6um NICKEL
- 3. SOLDER RESIST: APPLY TO BOTH SIDES COLOUR BLUE
- 4. COMPONENT IDENT: COLOUR TO BE WHITE
- 5. PANELIZE THE BOARD (4PCS PER PANEL). PLACE FIDUCIALS ON THE PANEL STRIPS AS FOLLOWS: - FIDUCIAL DIAMTER 1-1.5MM, SOLDER MASK OPENING AT LEAST 1MM GREATER THAN FIDUCIAL

 - MINIMUM 4MM DISTANCE FROM THE PANEL EDGE 3 FIDUCIALS SHOULD LIE ON TWO LINES THAT INTERSECT AT A RIGHT ANGLE PLACE ONE FIDUCIAL INTO EACH PANEL CORNER (FOUR ON THE TOP LAYER)

Board Stack Report